#### LCD / LCM SPECIFICATION



## WINSTAR Display Co.,Ltd. 華凌光電股份有限公司





WEB: <u>https://www.winstar.com.tw</u> E-mail: sales@winstar.com.tw

#### **SPECIFICATION**

**CUSTOMER** :

**MODULE NO.:** 

WO12864C2-TFH#

**APPROVED BY:** 

(FOR CUSTOMER USE ONLY)

**PCB VERSION:** 

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
AND S			

VERSION	DATE	REVISED PAGE NO.	SUMMARY
L	2020/12/15		Add Interface

Wi	nstar Displa	y Co.,	MODLE NO :				
華,	凌光電股份有限	<b>公司</b>					
REC	ORDS OF REV	<b>VISION</b>	DOC. FIRST ISSUE				
VERSION	DATE	REVISED PAGE NO.	SUMMARY				
0	2009/01/15		First issue				
Α	2009/02/20		Correct IC=ST7565P				
В	2011/05/03		Modify V0-VSS				
С	2012/07/17		Modify Backlight				
			Information				
D	2013/11/21		Remove IC information				
			Add Pull Tape				
E	2014/09/30		Correct Response Time.				
F	2016/01/27		Modify Precautions in use				
			of LCD Modules				
			& Static electricity test				
G	2016/11/18		Add FPC bending rule				
H	2018/12/03		Modify Luminance.				
Ι	2019/07/23		Correct Interface Pin				
			Function.				
J	2019/08/27		Modify Material List of				
			Components for RoHs				
K	2019/12/17		Modify Precautions in use				
			of LCD Modules				
L	2020/12/15		Add Interface				

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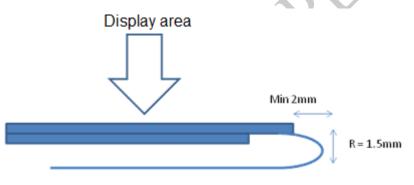
#### Contents

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- **3.General Specification**
- 4. Absolute Maximum Ratings
- **5.**Electrical Characteristics
- **6.Optical Characteristics**
- 7.Interface Pin Function
- 8.Contour Drawing &Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

.Modul	e Cla	ssific	ati	<u>on</u>	Inf	for	mat	tion
W O	12864	$C^{2}$		т	F	ц		#
$\frac{\mathbf{W}}{\mathbf{O}}$ $\frac{\mathbf{O}}{\mathbf{O}}$	<u>12804</u> 3	<u>C2</u> ④		<u>T</u> ©	<u>F</u> ©	<u>H</u> Ø		<u>#</u> ®
D Brand : WINST	TAR DISPLAY	CORPORA	TION					
Display Type :	H→Character	Type, G→G	raphic T	ype , X	→TAB	Type, (	)→COC	3 Туре
3 Display Font :	128 * 64 dot							
Definition Model serials not	).							XQY
D Backlight Type	$: N \rightarrow With$	out backlight	t T⇒	LED,	White	L⇒	LED, F	ull color
	B→EL, I	Blue green	A—	>LED,	Amber	J→	DIP LEI	D,Blue
	D→EL, (	Green	R	►LED, I	Red	K-	>DIP LE	D,White
	W→EL,	White	0-	>LED,	Orange	E→	DIP LE	D, Yellow Gr
	M→EL,	Yellow Green	n G-	→LED,	Green	H	→DIP LE	D,Amber
	F→CCFI	L, White	P⇒	LED, I	Blue	I→	DIP LEI	D, Red
	Y→LED	, Yellow Gree	en X—	→LED,	Dual co	lor		
	G→LED	, Green	C	>LED,	Full col	or		
D LCD Mode :	B→TN P	ositive, Gray			V→FST	ГN Neg	ative, Bl	lue
	N→TN N	Negative,			T→FS1	IN Neg	ative, Bl	ack
	$L \rightarrow VAN$	legative			D→FST	ГN Neg	ative (D	ouble film)
	$H \rightarrow HT$	N Positive, G	iray		F→FST	'N Posi	tive	
	I→HTN	Negative, Bla	ack		K→FSO	C Negat	tive	
	U→HTN	Negative, B	lue	1	S→FSC	<sup>2</sup> Positi	ve	
	M→STN	Negative, B	lue	E→ISTN Negative, Black				
		Positive, Gra	•		C→CS	ΓN Neg	gative, B	lack
	Y→STN	Positive, Yel	low Gre	en	A→AS'	TN Neg	gative, B	lack
D LCD Polarize		ective, N.T, 6		H→T	ransflec	ctive, W	V.T,6:00	
Type/ Temperat		ective, N.T, 1					V.T,12:00	
range/ View	G→Refle	ective, W. T,	6:00		ransmis			
direction		ctive, W. T, 1				,	.T,12:00	
		sflective, N.T					T, 6:00	
		sflective, N.T					Y.T,12:00	
Special Code	#:Fit in w	ith the ROH	S Direct	ions an	d regula	tions		

#### **2.Precautions in use of LCD Modules**

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

## **3.General Specification**

Item	Dimension	Unit
Number of Characters	128 x 64 dots	
Module dimension	55.2x 39.8 x 6.5(MAX)	mm
View area	45.2 x 27.0	mm
Active area	40.92 x 24.28	mm
Dot size	0.28 x 0.34	mm
Dot pitch	0.32 x 0.38	mm
LCD type	FSTN Positive Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same ba	
Duty	1/64 , 1/9 Bias	
View direction	6 o'clock	
Backlight Type	LED White	
IC	ST7565P	
Interface	6800/8080/4-Line SPI	

### **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	°C
Storage Temperature	T <sub>ST</sub>	-30	_	+80	°C
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3		V0+0.3	V

### **5.Electrical Characteristics**

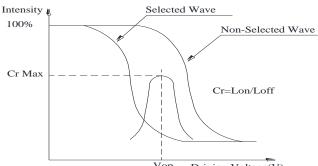
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V <sub>DD</sub> -V <sub>SS</sub>	_	2.7	3.0	3.3	V
		Ta=-20°C	_	—		V
Supply Voltage For LCM	VOP	Ta=25°C	9.4	9.6	9.8	v
		Ta=70°C	_	_	*	v
Input High Volt.	V <sub>IH</sub>	_	0.8 V <sub>DD</sub>	_	V <sub>DD</sub>	V
Input Low Volt.	V <sub>IL</sub>	_	Vss	$\sim$	$0.2 V_{DD}$	V
Output High Volt.	V <sub>OH</sub>	_	0.8 V <sub>DD</sub>	-	V <sub>DD</sub>	V
Output Low Volt.	V <sub>OL</sub>	_	Vss	_	$0.2V_{DD}$	V
Supply Current(No include	т	N 20N		0.40	1.0	
LED Backlight)	I <sub>DD</sub>	V <sub>DD</sub> =3.0V		0.49	1.0	mA

NOTE 1: Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance

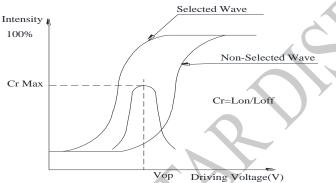
#### **6.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	$\theta$	$CR \ge 2$	0	—	30	$\phi = 180^{\circ}$
View Angle	$\theta$	$CR \ge 2$	0		60	$\phi = 0^{\circ}$
	θ	$CR \ge 2$	0		45	$\phi = 90^{\circ}$
	$\theta$	$CR \ge 2$	0		45	$\phi = 270^{\circ}$
Contrast Ratio	CR		_	5		_
	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

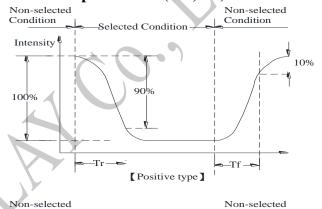
**Definition of Operation Voltage (Vop)** 

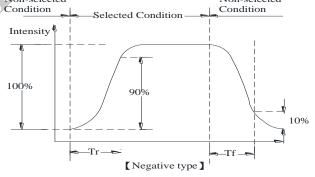


Vop Driving Voltage(V)



Definition of Response Time (Tr, Tf)





**Conditions :** 

Operating Voltage : Vop Frame Frequency : 64 HZ Definition of viewing angle( $CR \ge 2$ )

Viewing Angle( $\theta$ ,  $\varphi$ ): 0°, 0° Driving Waveform: 1/N duty, 1/a bias

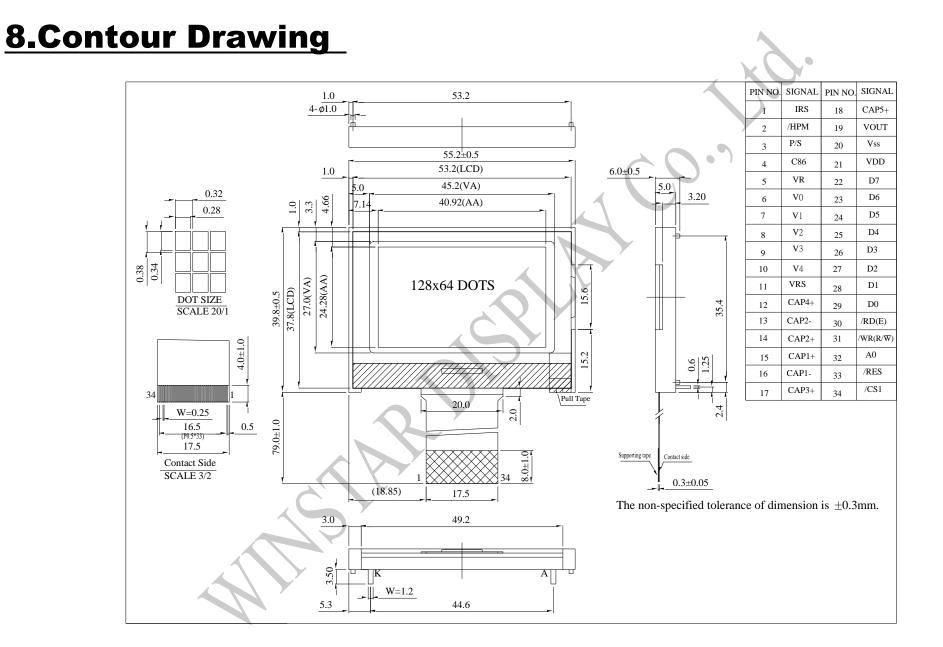
 $\varphi = 270^{\circ} - \cdots - \varphi = 90^{\circ}$ 

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## **7.Interface Pin Function**

Pin No.	Symbol	Level	Description							
1	IRS	Ι	This terminal selects the resistors for the V0 voltage level adjustment. IRS = "H": Use the internal resistors IRS = "L": Do not use the internal resistors. The V0 voltage level is regulated by an external resistive voltage divider attached to the VR terminal							
2	/HPM	Ι	crystal di /HPM =	This is the power control terminal for the power supply circuit for liquid crystal drive. /HPM = "H": Normal mode /HPM = "L": High power mode (Default)						
3	P/S	Ι	This is the parallel data input/serial data input switch terminal. $P/S = "H": Parallel data input.P/S = "L": Serial data input.The following applies depending on the P/S status:\boxed{P/S  Data/Command  Data  Read/Write  Serial Clock}"H"A0D0 to D7/RD, /WR"L"A0SI (D7)Write onlySCL (D6)When P/S = "L", D0 to D5 fixed "H".(RD (E) and /WR (R/W) are fixed to either "H" or "L".With serial data input, It is impossible read data from RAM$							
4	C86	Ι	C86 = "H	he MPU interfac H": 6800 Series L": 8080 Series	MPU inter	face.				
5	VR	Ι	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider. IRS = "L" : the V0 voltage regulator internal resistors are not used. IRS = "H" : the V0 voltage regulator internal resistors are used.							
6~10	V0~V4	Power Supply	This is a	multi-level pow	ver supply f	for the liquid	d crystal driv	ve.		
11	VRS	Power Supply	This is the internal-output VREG power supply for the LCD power supply voltage regulator.							
12	CAP4+	0	DC/DC voltage converter.							
13	CAP2-	Ο	DC/DC v	voltage converte 2P terminal.		a capacitor	between thi	s terminal and		

			DC/DC voltage converter. Connect a capacitor between this terminal and
14	CAP2+	0	the CAP2N terminal.
1 5	CAD1	0	DC/DC voltage converter. Connect a capacitor between this terminal and
15	CAP1+	0	the CAP1N terminal.
16		0	DC/DC voltage converter. Connect a capacitor between this terminal and
16	CAP1-	0	the CAP1P terminal.
17	CAP3+	0	DC/DC voltage converter. Connect a capacitor between this terminal and
17	CAP5+	0	the CAP1N terminal.
18	CAP5+	0	DC/DC voltage converter.
19	VOUT	0	DC/DC voltage converter. Connect a capacitor between this terminal and
19	VOUT	0	vss or VDD
20	VSS	Power	Ground
20		Supply	
21	VDD	Power	Power supply
		Supply	
22~29	D7~D0	I/O	Data bus line
			When connected to 2020 garing MBU, this pip is treated as the "/BD"
			• When connected to 8080 series MPU, this pin is treated as the "/RD"
			signal of the 8080 MPU and is LOW-active. The data bus is in an output status when this signal is "L".
30	/RD(E)	Ι	• When connected to 6800 series MPU, this pin is treated as the "E"
			signal of the 6800 MPU and is HIGH-active.
			This is the enable clock input terminal of the 6800 Series MPU.
			• When connected to 8080 series MPU, this pin is treated as the "/WR"
			signal of the 8080 MPU and is LOW-active.
			The signals on the data bus are latched at the rising edge of the /WR
			signal.
31	/WR(R/W)	I	• When connected to 6800 series MPU, this pin is treated as the "R/W"
	× C		signal of the 6800 MPU and decides the access type :
		$\mathbf{i}$	When $R/W = "H"$ : Read.
			When $R/W = "L"$ : Write.
			This is connect to the least significant bit of the normal MPU address bus,
			and it determines whether the data bits are data or command.
32	A0	Ι	A0 = "H": Indicates that D0 to D7 are display data.
			A0 = "L": Indicates that D0 to D7 are control data.
33	/RES	Ι	When RES is set to "L", the setting are initialized.



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## 9.Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

Environmental Test								
Test Item	Content of Test	Test Condition	Not e					
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2					
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs						
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1					
High Temperature/ Humidity storage	The module should be allowed to stand at 60 $^{\circ}$ C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}C$ $25^{\circ}C$ $70^{\circ}C$ 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles						
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= $\pm 600$ V(contact), $\pm 800$ v(air), RS= $330$ Ω CS= $150$ pF 10 times						

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

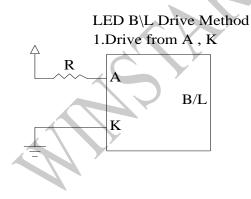
## **10.Backlight Information**

#### Specification

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	36	48	60	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	×Ò
Reverse Voltage	VR	_	_	5	V	-
Luminance	IV	800	1000			ILED=48mA
(Without LCD)	IV	800	1000		CD/M <sup>2</sup>	ILED=40IIIA
LED Life Time					1	Iled≦48mA
(For Reference	_	—	50000	-	Hr.	25°C,50-60%RH,
only)						(Note 1)
Color	White					•

Note: The LED of B/L is drive by current only; driving voltage is only for reference To make driving current in safety area (waste current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

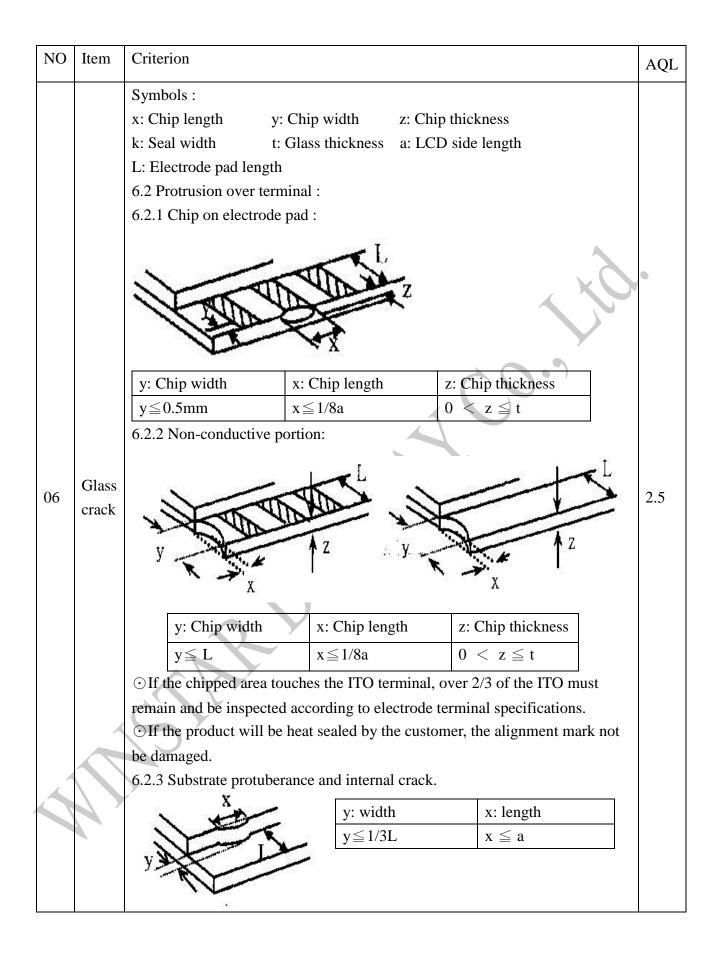


## **11.Inspection specification**

NO	Item	Criterion				AQL		
		Missing vertical	, horizonta	al segment, segme	nt contrast defect.			
		Missing character, dot or icon.						
		Display malfunction.						
01	Electrical	No function or r	0.65					
01	Testing	Current consum	ption exce	tion exceeds product specifications.				
		LCD viewing angle defect.						
		Mixed product t	ypes.					
		Contrast defect.						
	Black or	2 1 White and b	lack spots	on display $< 0.25$	mm, no more than			
02	white spots on	three white or bl	-			2.5		
02	LCD (display		-	-	s or lines within 3mm	2.5		
	only)							
		3.1 Round type	: As follov	ving drawing				
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY			
				$\Phi \leq 0.10$	Accept no dense			
				$0.10 \! < \! \Phi \! \le \! 0.20$	2			
				$0.20 \! < \! \Phi \! \le \! 0.25$	1	2.5		
				$0.25\!<\!\Phi$	0	2.5		
	LCD black	x			·			
	spots, white		¥					
03	spots,	. 🗨 .	TY					
	contamination		T					
	(non-display)	3.2 Line type : (	As follow	ing drawing)				
			Length	Width	Acceptable Q TY			
				$W \leq 0.02$	Accept no dense			
			L≦3.0	$0.02 \! < \! W \! \le \! 0.03$	_ 2	2.5		
			L≦2.5	$0.03 \! < \! W \! \le \! 0.05$	2			
				0.05 < W	As round type			

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD bla	ck spots, white spots, co	ontamination	
		Symbols Define:			
		x: Chip length y	: Chip width z: Ch	nip thickness	
		k: Seal width t	: Glass thickness a: LO	CD side length	
		L: Electrode pad lengtl	h:		
		6.1 General glass chip	:		
		6.1.1 Chip on panel su	rface and crack between	panels:	
				y 1	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	2.5
00	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
		⊙ If there are 2 or mor 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
		$Z \leq 1/2t$	Not over viewing area	$x \le 1/8a$	
		$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	
		$\odot$ If there are 2 or more	e chips, x is the total len	igth of each chip.	



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10		characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
		X	
		$X * Y \le 2mm^2$	
~		11.1 No un-melted solder paste may be present on the PCB.	2.5
$\mathbf{A}$		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	•
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

# **12.Material List of Components for**

## <u>RoHs</u>

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

2.Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow : 250°C,30 seconds Max. ;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. :  $235\pm5^{\circ}C$ ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

#### **13.Recommendable Storage**

- 1. Place the panel or module in the temperature  $25^{\circ}C\pm 5^{\circ}C$  and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

	winstar <u>LCM Samp</u>	le Estima	te Feedback Sheet
Module	e Number:		Page: 1
1 <u> </u>	Panel Specification		
1.	Panel Type :	Pass	□ NG ,
2.	View Direction:	Pass	□ NG ,
3.	Numbers of Dots:	Pass	□ NG ,
4.	View Area:	Pass	□ NG ,
5.	Active Area :	Pass	□ NG ,
6.	Operating Temperature :	Pass	□ NG ,
7.	Storage Temperature :	Pass	□ NG ,
8.	Others :		
2 · <u>N</u>	Aechanical Specification		
1.	PCB Size :	Pass	□ NG ,
2.	Frame Size :	Pass	□ NG ,
3.	Materal of Frame :	Pass	□ NG ,
4.	Connector Position:	Pass	□ NG ,
5.	Fix Hole Position :	Pass	□ NG ,
6.	Backlight Position :	Pass	□ NG ,
7.	Thickness of PCB :	Derived Pass	□ NG ,
8.	Height of Frame to PCB :	<b>Pass</b>	○ NG ,
9.	Height of Module :	Pass	□ NG ,
10	. Others :	<b>Pass</b>	□ NG ,
	Relative Hole Size		
	Pitch of Connector :	Pass	□ NG ,
2.	Hole size of Connector :	Pass	□ NG ,
3.	Mounting Hole size :	Pass	□ NG ,
	Mounting Hole Type :	Pass	□ NG ,
	Others :	Pass	□ NG ,
	acklight Specification		
	B/L Type :	Pass	□ NG ,
	B/L Color:	<b>Pass</b>	□ NG ,
	B/L Driving Voltage (Refere		
	B/L Driving Current :	Pass	□ NG ,
	Brightness of B/L:	Pass	□ NG ,
	B/L Solder Method :	Pass	□ NG ,
7.	Others :	Pass	□ NG ,
		>> Go	to page 2 <<

**WINSTAR** 

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odule Number:		Page: 2
5 • <u>Electronic Characteristics of</u>	f Module	
1. Input Voltage :	Pass	□ NG ,
2. Supply Current :	Pass	□ NG ,
3. Driving Voltage for LCD :	Pass	□ NG ,
4. Contrast for LCD :	Pass	□ NG ,
5. B/L Driving Method :	Pass	□ NG ,
6. Negative Voltage Output :	Pass	□ NG ,
7. Interface Function :	Pass	🗆 NG ,
8. LCD Uniformity :	Pass	$\Box$ NG ,
9. ESD test :	Pass	□ NG ,
10. Others :	Pass	□ NG ,
6 × <u>Summary</u> :		
SA		